

BD176/178/180

Medium Power Linear and Switching Applications

Complement to BD 175/177/179 respectively



PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Paramo	eter	Value	Units
V_{CBO}	*Collector-Base Voltage	: BD176	- 45	V
020		: BD178	- 60	V
		: BD180	- 80	V
V _{CEO}	Collector-Emitter Voltage	: BD176	- 45	V
		: BD178	- 60	V
		: BD180	- 80	V
V _{EBO}	Emitter-Base Voltage		- 5	V
I _C	Collector Current (DC)		- 3	Α
Ic	*Collector Current (Pulse)		- 7	Α
P _C	Collector Dissipation (T _C =25°C)		30	W
$R_{\theta ja}$	Junction to Ambient		70	°C/W
$R_{\theta jc}$	Junction to Case		8.5	°C/W
T _J	Junction Temperature		150	°C
T _{STG}	Storage Temperature		- 65 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	* Collector-Emitter Sustaining Voltage					
	: BD176	$I_C = -100 \text{mA}, I_B = 0$	- 45			V
	: BD178		- 60			V
	: BD180		- 80			V
I _{CBO}	Collector Cut-off Current : BD176	$V_{CB} = -45V, I_{E} = 0$			- 100	μΑ
	: BD178	$V_{CB} = -60V, I_{E} = 0$			- 100	μΑ
	: BD180	$V_{CB} = -80V, I_{E} = 0$			- 100	μΑ
I _{EBO}	Emitter Cut-off Current	$V_{EB} = -5V, I_{C} = 0$			- 1	mA
h _{FF1}	* DC Current Gain	$V_{CF} = -2V, I_{C} = -150 \text{mA}$	40		250	
h _{FE2}		$V_{CE} = -2V, I_{C} = -1A$	15			
V _{CE} (sat)	* Collector-Emitter Saturation Voltage	$I_C = -1 A$, $I_B = -0.1A$			- 0.8	V
V _{BE} (on)	* Base-Emitter On Voltage	$V_{CE} = -2V, I_{C} = -1 A$			- 1.3	V
f _T	Current Gain Bandwidth Product	$V_{CE} = -10V, I_{C} = -250mA$	3			MHz

^{*} Pulse Test: PW=300μs, duty Cycle=1.5% Pulsed

h_{FE} Classificntion

Classification	6	10	16
h _{FE1}	40 ~ 100	63 ~ 160	100 ~ 250
* Classification 16: Only BD 176			

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Typical Characteristics

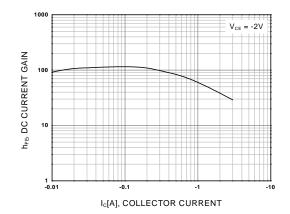


Figure 1. DC current Gain

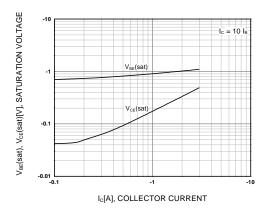


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

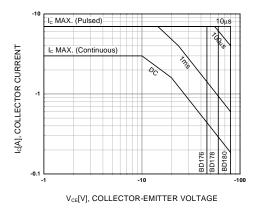


Figure 3. Safe Operating Area

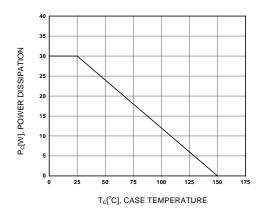
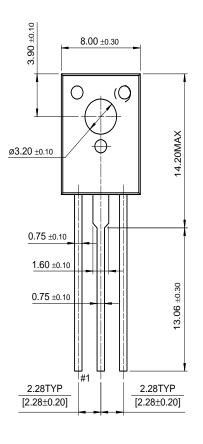


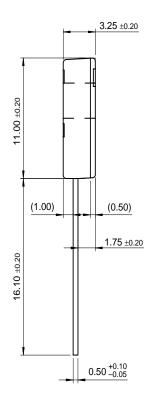
Figure 4. Power Derating

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Package Dimensions

TO-126





Dimensions in Millimeters

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